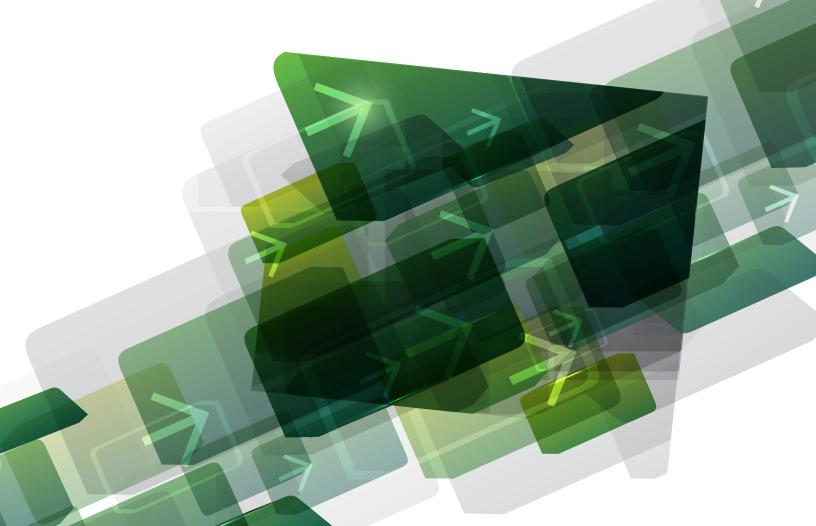


PCI Express High Speed Fabric

A complete solution for high speed system connectivity



Introduction

Maximizing application performance is a combination of processing, communication, and software. PCle Fabrics combine all three elements. A PCle Fabric connects Processors, I/O devices, FPGAs and GPUs into an intelligent fabric. This fabric connects devices through flexible cabling or fixed backplanes. PCle Fabrics main goal is to eliminate system communication bottlenecks, allowing applications to reach their potential. To accomplish this, PCle Fabrics deliver the lowest latency possible, combined with high data rates.

Dolphin's PCle Fabric solution consists of standard computer networking hardware and eXpressWare™ PCle software. Our standard form factor boards and switches reduce time to market, enabling customers to rapidly develop and deploy PCle Fabric solutions for data centers and embedded systems. eXpressWare™ software enables reuse of existing applications and development of new exciting applications, both with better response times and data accessibility. eXpressWare™ SuperSocket™ and IPoPCle software ensures quick application deployment by not requiring any application modifications. Application tuning is available with our low level SISCI shared memory API that delivers maximum performance.

The PCI Express standard's continued performance improvements and low cost infrastructure is ideal for application and system development. The current PCI Express solutions are at 128 GT/s. The PCIe road map extends speeds to 256 GT/s and 512 GT/s, while still maintaining backward compatibility. Standard PCIe commercial components are used by Dolphin as a road map to high performance hardware. Dolphin's solution exploits the PCI Express infrastructure to deliver next generation systems with maxim application performance. Our easy to implement and deploy solution gives customers the choice of changing or not changing their existing applications, but still taking advantage of PCI Express performance.

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Why PCI Express?

Performance

PCI Express solutions deliver outstanding performance compared to other interconnects in latency and throughput. When compared to standard 10 Gb/s Ethernet, PCI Express latency is 1/10 the measured latency. This lower latency is achieved without special tuning or complex optimization schemes. Current solutions offer latencies starting at 540 nanoseconds memory to memory access.

In addition, Dolphin takes advantage of PCI Express high throughput. Our current Gen 3 x16 implementations achieve data rates exceeding 11 GB/s. Dolphin's eXpresWare™ software infrastructure allows customers to easily upgrade to next generation PCI Express with doubling bandwidth. No software changes are required. These products still maintain the low latency characteristic of PCI Express. An investment in low latency high performance Dolphin products yields dividends today and into the future.



PCle Throughput

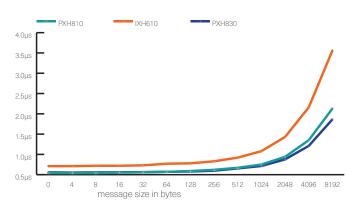


Figure 1: PCle Latency

Eliminate Software Bottlenecks

Dolphin's eXpressWare™ Software is aimed at performance critical applications. Advanced performance improving software, such as the SISCI API, removes traditional network bottlenecks. Sockets, IP, and custom shared memory applications utilize the low latency PIO and DMA operations within PCI Express to improve performance and reduce system overhead.

Software components include SuperSockets Sockets API, an optimized IPoPCIe driver for IP applications, SmartIO software for I/O optimization, and the SISCI shared memory API. Dolphin's SuperSockets software delivers latencies around 1 μ s and throughput at 65 Gb/s. The SISCI API offers further application optimization by using remote memory segments and multi-cast/ reflective memory operations. Customers benefit from even lower latencies with the SISCI API in the range of 0.54 μ s latency with higher throughput of over 11 GB/s. SmartIO software is used for peer to peer communication and moving devices between systems with device lending.

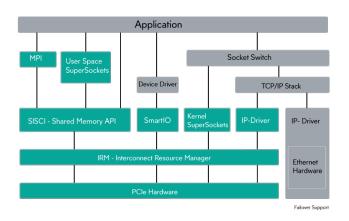


Figure 2: Dolphin eXpressWare™ Software Stack

Key Applications

- Financial Trading Applications
- High Availability Systems
- Real Time Simulators
- Databases and Clustered Databases
- Network File Systems
- High Speed Storage
- Video Information Distribution
- Virtual Reality Systems
- Range and Telemetry Systems
- Medical Equipment
- Distributed Sensor-to-Processor Systems
- High Speed Video Systems
- Distributed Shared Memory Systems

Robust Features

- Lowest host to host latency and low jitter with 0.54µs for fast connections and data movement
- DMA capabilities to move large amounts of data between nodes with low system overhead and low latency. Application to application transfers exceeding 11 GB/s throughput.
- Management software to enable and disable connection and fail over to other connections
- Direct access to local and remote memory, hardware based uni- and multi-cast capabilities
- Set up and manage PCle peer to peer device transfers
- High speed sockets and TCP/IP application support
- Ease installation and plug and play migration using standard network interfaces

High Performance Hardware

	Low profile PCIe Gen 2 and Gen 3 adapter cards provide high data rate transfers over standard cabling. These interface cards are used in standard servers and PCs deployed in high performance low latency applications. These cards incorporate standard iPass connectors and SFF-8644 connectors. They support both copper and fiber optic cabling, along with transparent and non-transparent bridging (NTB) operations.
To State of	XMC Adapters bring PCIe data rates and advanced connection features to embedded computers supporting standard XMC slots, VPX, VME or cPCI carrier boards. PCIe adapters expand the capabilities of embedded systems by enabling very low latency, high throughput cabled expansion and clustering. Standard PCs can easily connect to embedded systems using both XMC and host adapters.
	PCI Express Gen 3 switch boxes scale out PCIe Fabrics. Both transparent and non-transparent devices link to a PCIe switch, increasing both I/O and processing capacity. These low latency switches scale systems while maintaining high throughput.

PCIe Applications

SmartIO Technology

Remote Peer-to-Peer

PCle peer-to-peer communication (P2P) is a part of the PCl Express specification and enables regular PCIe devices to establish direct data transfers without the use of main memory as a temporary storage or the CPU for data movement as illustrated in figure 3. This significantly reduces communication latency. PCle Fabrics expand on this capability by enabling remote systems to establish P2P communication. Intel Phi, GPUs, FPGA, specialized data grabbers can exploit remote P2P communication to reduce latency and communication overhead.

The SISCI API supports this functionality and provides a simplified way to setup and manage remote peer-to-peer transfers. SISCI software enables applications to use PIO or DMA operations to move data directly to and from local or remote PCIe devices.

IO bridge FPGA Dolphin PCle FPGA System A System B CPU Figure 3: Peer to Peer transfers

System A

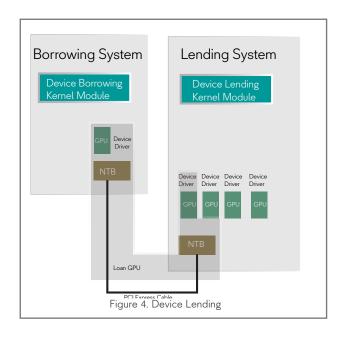
System B

PCle Device Lending Software

PCIe Device Lending offers a flexible way to enable PCIe IO devices (NVMes, FPGAs, GPUs etc) to be accessed within a PCle Fabric. Devices can be borrowed over the PCle Fabric without any software overhead at PCIe speeds. Device Lending is a simple way to reconfigure systems and reallocate resources. GPUs, NVMe drives or FPGAs can be added or removed without having to be physically installed in a system on the fabric. The result is a flexible simple method of creating a pool of devices that maximizes usage. Since this solution uses standard PCIe, it doesn't add any software overhead to the communication path. Standard PCle transactions are used between the systems. Dolphins eXpressWare software manages the connection and is responsible for setting up the PCIe Non-Transparent Bridge (NTB) mappings.

Two types of functions are implemented with device lending. These are the lending function and the borrowing function as outlined in figure 4. Lending involves making devices available on the fabric for temporary access. These PCIe devices are still located within the lending system. The borrowing function can lookup available devices. Devices can then be temporarily borrowed. When use of the device is completed, the device can be released and borrowed by other systems on the fabric or returned for local use.

Device lending also enables a SR-IOV device to be shared as a MR-IOV device. SR-IOV functions can be borrowed by any system in the PCle Fabric. Thereby enabling the device to be shared by multiple systems. This maximizes the use of SR-IOV devices such as 100 Gbit Ethernet cards



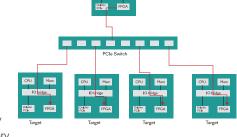
Reflective Memory / Multi-cast

Dolphin's reflective memory or multi-cast solution reinterprets traditional reflective memory offerings. Traditional Reflective Memory solutions, which have been on the market for many years, implement a slow ring based topology. Dolphin's reflective memory solution uses a modern high speed switched architecture that delivers lower latency and higher throughput.

Dolphin's PCle switched architecture employs multi-cast as a key element of our reflective memory solution. A single bus write transaction is sent to multiple remote targets or in PCl Express technical terms multi-cast capability enables a single Transaction Layer Packet (TLP) to be forwarded to multiple destinations. PCl Express multi-cast results in a lower latency and higher bandwidth reflective memory solution. Dolphin benchmarks show end-to-end latencies as low as $0.99\mu s$ and over $6000 \ MB/s$ data flow at the application level. These performance levels solve many real time, distributed computing requirements.

Dolphin combines PCI Express multi-cast with the eXpressWare™ SISCI (Software Infrastructure for Shared-memory Cluster Interconnect) API to allow customers to easily implement applications that directly access and utilize PCIe multi-cast. Applications can be built without the need to write device drivers or spend time studying PCIe chipset specifications.

Another main difference in Dolphin's reflective memory solution is the use of cached main system memory to store data. Cached main memory provides a significant performance and cost benefit. Remote interrupts or polling signal the arrival of data from a remote node. Polling is very fast since the memory



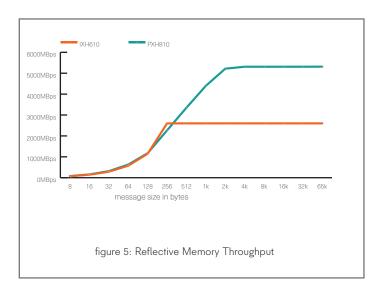
segments are normal cached main memory and consume no memory bandwidth. The CPU polls for changes in its local cache. When new data arrives from the remote node, the I/O system automatically invalidates the cache and the new value is cached.

In addition, FPGA and GPU applications can implement this reflective memory mechanism. The SISCI API configures and enables GPUs, FPGAs, or any PCIe master device to send data directly to remote memory through the multi-cast mechanism, avoiding the need to first store the data in local memory. Data is written directly from a FPGA to multiple end points for processing or data movement. FPGAs can also receive data from multiple end points.

Reflective memory solutions are known for their simplicity, just read and write into a shared distributed memory. Our high-performance fabric increases simplicity with easy installation and setup. The SISCI Developers Kit includes tools to speed development and setup of your reflective memory system. Once setup, your application simply reads and writes to remote memory.

Features

- High-performance, ultra low-latency switched 64 GT/s and 40 GT/s data rates
- Gen 3 x8 performance up to 6000 MB/s data throughput
- Gen 2 x8 performance up to 2886 MB/s data throughput
- FPGA, GPU support
- Hardware based multi-cast
- Configurable shared memory regions
- Fiber-Optic and copper cabling support
- Scalable switched architecture
- SISCI API support
- PCle host adapters
- Expandable switch solutions



eXpressWare[™] Software

PCI Express Software Suite

eXpressWare[™] software enables developers to easily migrate applications to PCle Fabrics. eXpressWare's[™] complete software infrastructure enables networking applications to communicate using standard PCle over cables and backplanes. Several interfaces and APIs are supported including standard TCP/IP networking - IPoPCle driver, a low level direct remote memory access API – SISCI shared memory API and a sockets API -SuperSockets[™]. Each API has its

benefits and can be selected based on application requirements.

The SISCI API enables customers to fully exploit the PCIe programming model without having to spend months developing device drivers. The API offers a C programming API for shared / remote memory access, including reflective memory/multi-cast functionality, peer to peer memory transfers and RDMA capabilities. The SISCI API supports direct FPGA to FPGA, GPU to GPU, or any combination of communication with FPGA, CPUs, GPUs or memory over PCIe.

SuperSockets[™] enables networked applications to benefit from a low

- PCle Gen 1,2,3 support
- Address based Multi-cast / reflective memory
- Point to point and switched fabric support
 - Scalable to 126 nodes
- Operating systems
 - Windows, Linux, VxWorks, RTX
- Low latency direct memory transfers
- Accelerated Loopback support
- Peer to peer transfers
- UDP and TCP support

latency, high throughput PCle Fabric without any modifications. With SuperSockets™, a PCle Fabric can replace local Ethernet networks. The combination of Dolphin's PCle host adapters and switches with SuperSockets™ delivers maximum application performance without necessitating application changes. SuperSockets™ is a unique implementation of the Berkeley Sockets API that capitalizes on the PCle transport to transparently achieve performance gains for existing socket-based network applications. Both Linux and Windows operating systems are supported, so new and existing applications can easily be deployed on future high performance PCle Fabrics.

Dolphin's performance optimized TCP IP driver for PCIe (IPoPCIe) provides a fast and transparent way for any networked applications to dramatically improve network throughput. The software is highly optimized to reduce system load (e.g. system interrupts) and uses both PIO and RDMA operations to implement the most efficient transfer of all message sizes. The major benefits are plug and play, much higher bandwidth, and lower latency than network technologies like 10Gb/s Ethernet. The IPoPCIe driver is targeted for non-sockets applications and functions that require high throughput.

- UDP multi-cast
- Cascading of switches
- FPGA and GPU direct memory transfers
- Low latency direct memory transfers
- PCle chipset support
 - Microsemi, Broadcom /PLX, IDT, ntel NTB
- Cross O/S low latency data transfers
- Sockets Support
 - Berkeley Sockets, WinSock 2
- Fabric manager

Specifications

Supported APIs	SISCI API Berkley Sockets API Microsoft WinSock2/LSP support TCP/IP	Supported Platforms	x86 ARM 32 bit and 64 bit PowerPC
Application Performance Supported Components	0.54 microsecond latency (application to application) Above 11 GB/s throughput Microsemi	eXpressWare [™] Packages Dolphin Software	eXpressWare™ for Linux eXpressWare™ for Windows eXpressWare™ for RTX eXpressWare™ for VxWorks
Supported Components	Broadcom/PLX IDT Intel NTB enabled servers		SuperSockets for Windows SuperSockets for Linux IPoPCle driver
PCI Express	Base Specification 1.x, 2.x, 3.x Link widths 1-16 lanes		SISCI API IRM- Interconnect Resource Manager PCIe Fabric Manager
Topologies	Switch/ point to point/ mesh		1 Old Fabric Flantager

eXpressWare™ Software

IPoPCle IP over PCle

Dolphin's performance optimized TCP IP driver for PCIe (IPoPCIe) is targeted at non-sockets applications that require high throughput along with plug and play. This fast and transparent network driver dramatically improves network throughput. The software is highly optimized to reduce system load (e.g. system interrupts) and uses both PIO and RDMA operations to implement the most efficient transfers of all message sizes. IPoPCIe offers much higher bandwidth and lower latency than standard network technologies like 40 GbE. Figure 4 illustrates the performance with Gen2 and Gen3 PCIe cards.

At the hardware level, the TCP/IP driver provides a very low latency connection. Yet, operating system networking protocols typically introduce a significant delay for safe networking (required for non-reliable networks like Ethernet). The IPoPCIe driver still implements these networking protocols increasing latency. User space applications seeking the lowest possible network latency should utilize the Dolphin SuperSockets[™] technology. The IPoPCIe driver will typically provide 5-6 times better throughput than 10G Ethernet.

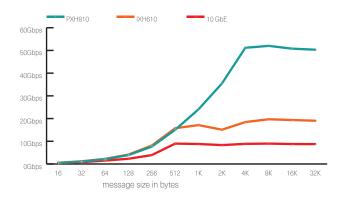


Figure 6: TCP/IP Throughput

Features

- All networked, users space and kernel space applications are supported.
- 100% compliant with Linux Socket library, Berkeley Socket API and Windows WinSock2.
- No OS patches or application modifications required. Just install and run
- Routing between networks

- ARP support
- Both TCP and UDP supported. (UDP multi-cast/broadcast is not supported yet using Linux, but SuperSockets for Linux supports UDP multi-cast)
- Supports hot-pluggable links for high availability operation
- Easy to install

IPoPCle Uses

The optimized TCP/IP driver is recommended for applications like

Windows

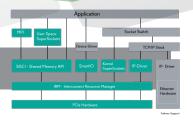
- Microsoft Hyper-V live migration
- Network file sharing (map network drive)
- Applications that require UDP (not support by SuperSockets yet).

Linux:

- General networking
- NFS
- Cluster file systems not supported by SuperSockets
- iSCSI

eXpressWare™ Software

SISCI Low Level API



Dolphin's Software Infrastructure Shared-Memory Cluster Interconnect (SISCI) API makes developing PCI Express Fabric applications faster and easier. The SISCI API is a well established API for shared memory environments. In PCI Express multiprocessing architectures, the SISCI API enables PCIe based applications to use distributed resources such as CPUs, I/O, and memory. The resulting applications feature reduced system latency and increased data throughput.

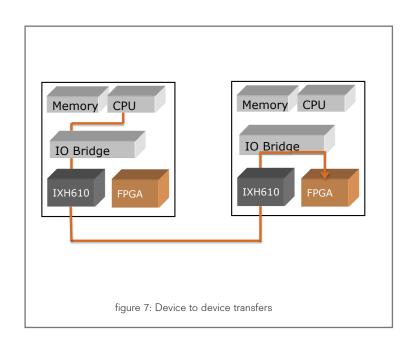
For processor to processor communication, PCI Express supports both CPU driven programmed IO (PIO) and Direct Memory Access (DMA) as transports through non-transparent bridges (NTB). Dolphin's SISCI API utilizes these components in creating a development and runtime environment for systems seeking maximum performance. This very deterministic environment featuring low latency and low jitter is ideal for traditional high performance applications like real time simulators, reflective memory applications, high availability servers with fast fail-over, and high speed trading applications.

The SISCI API supports data transfers between applications and processes running in an SMP environment as well as between independent servers. SISCI's capabilities include managing and triggering of application specific local and remote interrupts, along with catching and managing events generated by the underlying PCIe system (such as a cable being unplugged). The SISCI API makes extensive use of the "resource" concept. Resources are items such as virtual devices, memory segments, and DMA queues.

The API removes the need to understand and manage low level PCIe chip registers. At the application level, developers utilize these resources without sacrificing performance. Programming features include allocating memory segments, mapping local and remote memory segments into addressable program space, and data management and transfer with DMA. The SISCI API improves overall system performance and availability with advanced caching techniques, data checking for data transfer errors, and data error correction.

Features

- Shared memory API
- PCI Express Peer to Peer support
- Replicated/reflective memory support
- Distributed shared memory and DMA support
- Low latency messaging API
- Interrupt management
- Direct memory reads and writes
- Windows, RTX, VxWorks, and Linux support
- Supports data transfers between all supported OS and platforms.
- Caching and error checking support
- Events and callbacks
- Example code available



eXpressWare[™] Software

Why use SISCI?

The SISCI software and underlying drivers simplify the process of building shared memory based applications. For PCIe based application development, the API utilizes PCI Express non-transparent bridging to maximum application performance.

The shared memory API drivers allocate memory segments on the local node and make this memory available to other nodes. The local node then connects to memory segments on remote nodes.

Once available, a memory segment is accessed in two ways, either mapped into the address space of your process and accessed as a normal memory access, e.g. via pointer operations, or use the DMA engine in the PCle chipset to transfer data. Figure 6 illustrates both data transfer options.

data may already exist in the CPU cache, and the actual transfer is just a single CPU instruction – a write posted store instruction. A DMA implementations saves CPU cycles for larger transfers, enabling overlapped data transfers and computations.

overlapped data transfers and computations DMA has a higher setup cost so latencies usually increase slightly because of the time required to lock down memory and setup the DMA engine and interrupt completion time. However, more data transfers joined and sent together to the PCle switch in order amortizes the overhead.

The built in resource management enables multiple concurrent SISCI programs and other users of the PCIe Fabric to coexist and operate independent of each other. The SISCI API is available in user space and a similar API is available in kernel

Segment Dolphin Adapter

MA Data Movement

Segment Segment Dolphin Adapter

Segment Dolphin Adapter

Segment Dolphin Adapter

Segment Dolphin Adapter

Dolphin Adapter

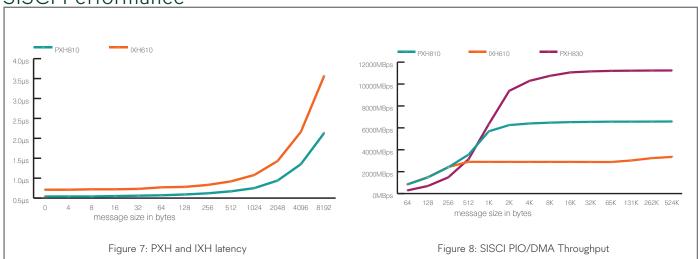
Dolphin Adapter

figure 8: SISCI data movement model

Mapping the remote address space and using PIO may be appropriate for control messages and data transfers up to e.g. 1k bytes, since the processor moves the data with very low latency. PIO optimizes small write transfers by requiring no memory lock down,

space. Itatiaes occhui fachi, niciam

SISCI Performance



The SISCI API provides applications direct access to the low latency messaging enabled by PCI Express. Dolphin SISCI benchmarks show latencies as low as 0.54 μ s. The chart on Figure 7 show the latency at various message sizes. The SISCI API enables high throughput applications. This high performance API takes advantage of the PCI Express hardware performance to deliver over

11 GB/s for Gen 3 and 3500 MB/s for Gen 2 of real application data throughput. Figure 8 shows the throughput at various message sizes using Dolphin IXH and PXH host adapters



SuperSockets™

PCI Express can replace local Ethernet networks with a high speed low latency network. SuperSockets is a unique implementation of the Berkeley Sockets API. With SuperSockets , network applications transparently capitalize on the PCIe transport to achieve performance gains.

Dolphin PCIe hardware and the SuperSockets software support the most demanding sockets based applications with an ultra-low latency, high-bandwidth, low overhead, and highly available platform. New and existing Linux and Windows applications require no modification to be deployed on Dolphin's high-performance platform.

Traditional implementations of TCP sockets require two major CPU consuming tasks: data copy between application buffers and NIC buffers along with TCP transport handling (segmentation, reassembly, check summing, timers, acknowledgments, etc). These operations turn into performance bottlenecks as I/O interconnect speeds increase. SuperSockets eliminates the protocol stack bottlenecks, delivering superior latency performance. Our ultra-low latency remote memory access mechanism is based on a combination of PIO (Programmed IO) for short transfers and DMA (Direct Memory Access) for longer transfers, allowing both control and data messages

to experience performance improvements.

SuperSockets is unique in its support for PIO. PIO has clear advantages for short messages, such as control messages for simulations systems. Transfers complete through a single CPU store operation that moves data from CPU registers into remote system memory. In most cases, SuperSockets data transfers complete before alternative technologies start their RDMA transfer.

In addition to PIO, SuperSockets implements a high-speed loopback device for accelerating local system sockets communication. This reduces local sockets latency to a minimum. For SMP systems, loopback performance is increased 10 times.

SuperSockets comes with built in high availability, providing instantaneous switching during system or network errors. If the PCI Express® Fabric fails, socket communication transfers to the regular network stack. The Linux version supports an instant fail- over and fail-forward mechanism between the PCIe and regular network.

Features

- Windows and Linux support
- Full support for socket inheritance/duplication
- Includes local loopback socket acceleration up to 10 times faster than standard Linux and Windows
- No OS patches or application modifications required
- Easy to install with no application modifications
- Linux to Windows connectivity available soon

Linux Specific Features

- TCP, UDP, and UDP multi-cast support
- Supports both user space and kernel space applications
- Compliant with Linux Kernel Socket library and Berkeley Sockets
- Transparent fail-over to Ethernet if high speed connection fails and falls back when problem is corrected

Windows Specific Features

- TCP support, UDP and UDP multi-cast being implemented
- Supports user space applications
- Compliant with WinSock2 API
- Fail-over to Ethernet if high speed connection is not available at start-up

eXpressWare[™] Software

How Does SuperSockets[™] Work?

To divert socket communication without touching the application, the sockets API functions must be intercepted. This is done differently in Windows and Linux environments.

Dolphin SuperSockets on Linux differs from regular sockets only in the address family. SuperSockets implement an AF_INET compliant socket transport called AF_SSOCK. The Linux LD_PRELOAD functionality is used to preload the standard sockets library with a special SuperSockets library that intercepts the socket () call and replaces the AF_INET address family with AF_SSOCK. All other sockets calls follow the usual code path. Target addresses within the PCI Express Fabric are accelerated by the SuperSockets module.

For Windows applications or services, a Layered Service Provider(LPS) module is installed and automatically configured. The LSP accelerates socket transfers initiated by AF_INET or AF_INET6, SOCK_STREAM endpoints. The SuperSockets stack provides a proxy application called dis_ssocks_run.exe that enables specific

programs to use the PCI Express path. By default, the LSP is a pass-through module for all applications: the network traffic passes through the NDIS stack.

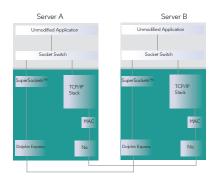


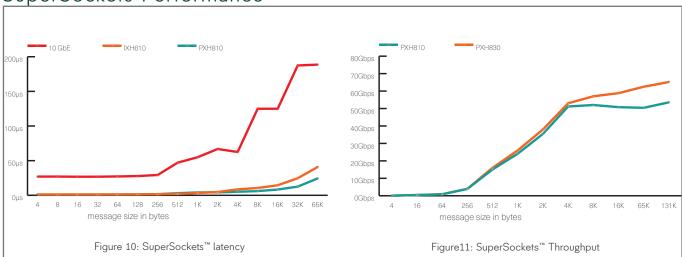
figure 9: SuperSockets™ vs. Ethernet data model

The network acceleration over PCI Express occurs when the interconnect topology is fully functional, the client and server programs are launched under the proxy application's control and both sides use the standard Winsock2 API calls. At runtime, a native socket is created and used for initial connection establishment. Therefore, all connections are subject to typical network administrative policies.

The supported transfer modes are blocking, non-blocking, overlapped, asynchronous

window and network events. The Service Provider balances the CPU consumption based on the traffic pattern. Dedicated operating system performance counters are additionally provided.

SuperSockets **Performance



SuperSockets is optimized for high throughput, low latency communication by reducing system resource and interrupt usage in data transfers. The latency chart above shows performance results using PCI Express vs 10 Gigabit Ethernet. The socket ping-pong test shows the half RTT (Round Trip Time). The minimum latency for Dolphin SuperSockets is under 1 microseconds. SuperSockets also delivers high throughput with over 53 Gb/s of data throughput with our Gen3 PXH810 product.

PCIe NTB Adapters

Dolphin's PCI Express NTB Host Adapter are high performance cabled interface to external processor subsystems. Based on standard PCI Express bridging architectures, the host adapters include advanced features for non-transparent bridging (NTB) and clock isolation.

These host adapter combine high performance with an application to application latency starting at sub-1 microsecond. They support both Remote Direct Memory Access (RDMA) and Programmed IO (PIO) transfers, effectively supporting both large and small data packets. RDMA transfers result in efficient larger packet transfers and processor off-load. PIO transfers optimize small packet transfers at the lowest latency. The combination of RDMA and PIO creates a highly potent data transfer system.

All PCIe NTB adapters support our eXpressWare[™] software suite which takes advantage of PCI Express' RDMA and PIO data transfer scheme. eXpressWare[™] software delivers a complete deployment environment for customized and standardized applications. The suite

includes a Shared-Memory Cluster Interconnect (SISCI) API as well as a TCP/IP driver and SuperSockets software. The SISCI API is a robust and powerful shared memory programming environment.

The optimized TCP/IP driver and SuperSockets™ software remove traditional networking bottlenecks, allowing standard IP and sockets applications to take advantage of the high-performance PCI Express interconnect without modification. The overall framework is designed for rapid development of inter-processor communication systems.

Our host adapters are carefully designed for maximum cable length. They supports copper cables at various lengths at full PCI Express speeds. Fiber optics are available on some models to extend cable distances up to 100 meters.

All NTB adapter cards come with a full license to the Dolphin eXpressWare software.

Features

- PCI Express compliant
- Link compliant with Gen1, Gen2, and Gen3 PCle
- RDMA support through PIO and DMA
- Copper and fiber-optic cable connections
- Full host clock isolation. Supports hosts running both CFC and SSC
- Non-transparent bridging to cabled PCI Express systems
- Low Profile PCle form factor
- EEPROM for custom system configuration
- Link status LEDs through face plate

Specifications

Dolphin Software	ohin Software SuperSockets Berkley Sockets API Microsoft WinSock2 /LSP support IPoPCIe driver	Operating Systems supported	Windows, RTX, Linux, VxWorks
Device Lending and Smar	SISCI API Device Lending and SmartIO -(excludes IX products)	Operating Environment	Operating Temperature: 0°C - 55°C (32°F - 131°F) Operating Temperature with AOC: 0°C - 45°C (32°F
PCle Bracket	Full height plate mounted Half height plate included		- 113°F) Air Flow: 150 LFM
Configuration	DIP-switch NTB /Long cable /short cable /safe boot		Operating Temperature: 0°C - 50°C (32°F - 122°F) Air Flow: ~0 LFM
Regulatory	CE Mark FCC Class A UL94V-0 compliant RoHS Compliant		Relative Humidity: 5% - 95% (non- condensing)

PXH830 Gen 3 PCIe NTB Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Quad SFF-8644 connector
 - » PCI Express 3.0 cables
 - » MiniSAS -HD cables

- Four x4 Gen3 PCI Express cable ports that can be configured as:
- One x16 PCI Express port
- Two x8 PCI Express ports
- Two NTB ports
- Copper and fiber-optic cable support

Specifications

Link Speeds	32 GT/s per port /128 GT/s	Power Consumption	10 Watts (typical, 14 Watts worst case) + 800 miliwatts (typical) pr connected x4 AOC
Application Performance	0.54 microsecond latency (application to application) <130 nanoseconds cut through latency port to port	Mechanical Dimensions	Low profile, Half Length - 68.90 mm (2.731 inches) x 167.65 mm (6.600 inches)
Active Components	Broadcom/PLX Gen 3 PCle Switch with DMA	Product Codes	PXH830 PCle Fabric Adapter
PCI Express	Base Specification 3		
Topologies	Point to point or 3 node Mesh Topology		
Cable Connections	Quad SFF-8644 connector PCIe 3.0 and MiniSAS HD cables Copper cables, 0.5 - 9 meters Fiber Optic -100 meters		

Cluster connections

When used for multi-processor connections, the PXH830 adapter is capable of connecting up to three nodes at Gen3 x8 without a switch as shown in figure 1 2 or two nodes at Gen3 x16. Each port is 32 GT/s. Two ports create a 64 GT/s x8 link. Four port create a 128 GT/s x16 link. All ports have latencies as low as 0.54 microseconds. The PXH830 supports any system with a standard x16 PCle slot.

Performance

Each connection supports 32 GT/s with a maximum of 128 GT/s. Figure 13 illustrates the latency at various packet sizes. The bottom axis are packet sizes the side axis is latency in microseconds. PXH830 latencies are as low as 0.54 microseconds.

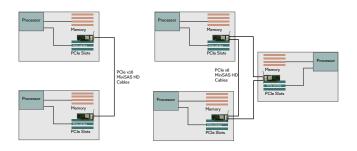


Figure 12: Switchless PXH830 Configurations

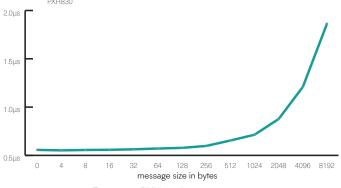


Figure 13: PXH830 Latency

PXH840 Gen 3 PCIe NTB Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Samtec FireFly Fiber optic
- Four x4 Gen3 PCI Express cable ports that can be configured as:
- One x16 PCI Express port
- Two x8 PCI Express ports
- Two NTB ports
- fiber-optic cable only

Specifications

Link Speeds	32 GT/s per port /128 GT/s	Power Consumption	10 Watts (typical, 14 Watts worst case) + 800 miliwatts
Application Performance	0.54 microsecond latency (application to application)		(typical) pr connected x4 AOC
	<130 nanoseconds cut through latency port to port	Mechanical Dimensions	Low profile, Half Length - 68.90 mm (2.731 inches) x
Active Components	Broadcom/PLX Gen 3 PCle Switch with DMA		167.65 mm (6.600 inches)
DOLE	D 0 ''' '' 0	Product Codes	PXH840 PCIe Fabric Adapter
PCI Express	Base Specification 3		
Topologies	Point to point or 3 node Mesh Topology		
Cable Connections	Samtec FireFly Transceivers Fiber Optic -100 meters		
Cable Connections	,		

Cluster connections

When used for multi-processor connections, the PXH830 adapter is capable of connecting up to three nodes at Gen3 x8 without a switch as shown in figure 12 or two nodes at Gen3 x16. Each port is 32 GT/s. Two ports create a 64 GT/s x8 link. Four port create a 128 GT/s x16 link. All ports have latencies as low as 0.54 microseconds. The PXH830 supports any system with a standard x16 PCle slot.

Performance

Each connection supports 32 GT/s with a maximum of 128 GT/s. Figure 15 illustrates the latency at various packet sizes. The bottom axis are packet sizes the side axis is latency in microseconds. PXH830 latencies are as low as 0.54 microseconds.

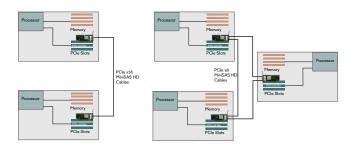


Figure 14: Switchless PXH830 Configurations

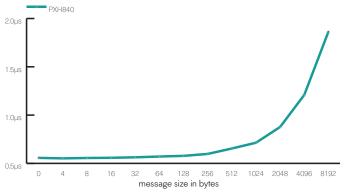


Figure 15: PXH840 Latency

MXH830 Gen 3 PCIe NTB Adapter

Features

- PCI Express Gen3 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Quad SFF-8644 connector
 - » PCI Express 3.0 cables
 - » MiniSAS -HD cables
- RDMA support through PIO and System DMA
- Copper and fiber-optic cable support
- <170ns Cut Through latency</p>

- MXH830 supports the following port configurations
 - » One x16 PCle port
 - » Two x8 PCle ports
 - » Four x4 PCle ports
- MXH830 can be configured into a 5 node cluster using 4 x4 ports to each host or a 3 node cluster using x8 connections, or a two node x16 connection
- Combined with the MXS824 can scale to up to 64 or 128 nodes

Specifications

<u> </u>			
Link Speeds	32GT/s per port / 128 GT/s total	Cable Connections	SFF-8644 connector for copper / fiber cables
Application Performance	~500ns latency (application to application) Above 10 Gbytes/s throughput		Supports 4 - x4/2 - x8 or 1 - x16 connections PCle 3.0 copper and MiniSAS-HD copper / fiber up to 9m with copper, 100m with fiber
Active Components	Microsemi Switchtec PFX Switch	Power Consumption	12 Volt: Max 19.6 Watts
PCI Express	Base Specification 3.1 Cable Specification 3.0 (preliminary) Card Electromechanical Specification 3.0	·	12 Volt: Max 24 Watts including AOC +3.3 Volt: Not connected +3.3 Volt AUX: Max 1 Watt
Topologies	Two nodes direct cable Three to five nodes mesh topology	Mechanical Dimensions Product Codes	Low profile - 69.2 mm (2.7 inches) x 168.2 mm (6.6 inches)
	Switched Topology with MXS824		MXH830 Host NTB Adapter
Cut-Through Latency	<170ns		

Cluster connections

When used for multi-processor connections, the MXH830 adapter is capable of connecting up to 5 nodes at Gen3 x4 without a switch as shown in figure 1 6 or three nodes at Gen3 x8 and 2 nodes at Gen3 x16. Each port is 32 GT/s. Two ports create a 64 GT/s x8 link. Four port create a 128 GT/s x16 link. The MXH830 supports any system with a standard x16 PCle slot.

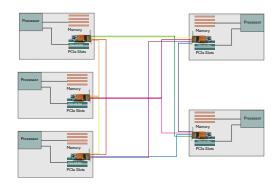


Figure 16: Five node MXH830 cluster

¹ System DMA is only available with select systems

PXH810 Gen 3 PCle NTB Adapter

Features

- Gen 3 64 GT/s
- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- PCle iPass Connectors
- One x8 PCle port
- RDMA support through PIO and DMA
- Non-transparent bridging

- Copper connection up to 5 meters
- Fiber-optic cable connection up to 100 meters
- Clock isolation, full CFC and SSC support
- Non-transparent bridging to cabled PCIe systems
- Low Profile PCIe form factor
- EEPROM for custom system configuration
- Link status LEDs through face plate

Specifications

Link Speeds 64 GT/s		Mechanical Dimensions	Low profile - 68.90 mm (2.731 inches) x
Application Performance	0.54 microsecond latency (application to application) 6595 MB/s throughput	Mounting Plates	120 mm (6.600 inches) Full height plate installed
Active Components	PLX PCI Express Switch		Half height plate included with board
PCI Express	Base Specification 3	Operating Systems supported	Windows, RTX, Linux, VxWorks
Topologies	Switch/ point to point		
Cable Connections	x8 iPass copper cable, fiber optic cable support Supports x8 to x4 transition cables	Product Codes	PXH810 Host NTB Adapter
Power Consumption	12 watts		

Cluster and I/O connections

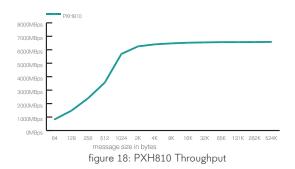
The PXH810 adapter delivers extremely high throughput. This is demonstrated by using the SISCI API. The PXH810 PCIe hardware performance delivers over 6500 MB/s of real application data throughput for high performance communication. Figure 17 shows the throughput at various message sizes using the PXH810 Gen 3 host adapters.

Performance

When used for inter-host connections, the PXH810 adapter is capable of node to node connections or connections through a IXS600 Switch as shown in figure 18. Each connection supports 64 GT/s with latencies as low as 0.54 microseconds. Designed for x8 PCle Systems, the PXH810 supports any system with a standard x8 or x16 PCle slot. Gen3 operation requires a system that supports Gen3 PCl Express.



figure 17: Eight node PXH810 cluster



IXH610 Gen2 PCle Host Adapters

Features

- PCI Express 2.1 compliant 5.0 GT/s per lane
- x8 PCI Express port 40 GT/s
- Link compliant with Gen1 and Gen2 PCI Express
- Support Gen1, Gen2, and Gen3 PCle Slots

- PCI Express External Cabling Specification
- PCI Express x8 iPass Connectors
- Copper cables up to 7 meters
- Non-transparent bridging to cabled PCle systems

Specifications

Link Speeds	40 GT/s	Mechanical Dimensions	PCI Express Card Electromechanical Specification 2.0
Application Performance	0.74 ms latency (application to application) 3,500 MB/s Throughput	Operating Environment	Operating Temperature: -10°C -60°C Relative Humidity: 5% -95% non-condensing
PCI Express	Base Specification 2.1	User Configuration Modes	Transparent Host Target adapter Non-transparent Host(NTB)
Topologies	Point to point, Switched		
Cable Connections	x8 iPass copper cable support Supports x8 to x4 transition cables	Product Codes	IXH610 - Host / NTB Adapter
Power Consumption	7 watts		

Cluster connections

When used for clustered connections, the IXH610 adapter is capable of node to node connections or connections through a IXS600 Switch as shown in figure 19. Adding industrial systems is done by connecting to the IXH620 XMC adapter. Each connection supports 40 GT/s with latencies as low as 0.74 microseconds. Designed for x8 PCle Systems, the IXH610 supports any system with a standard x8 or x16 PCle slot. The IXH631 uses MiniSAS HD connectors to create up to a 5 node cluster without a switch.



Figure 19: Eight node PCI Express Cluster

PCle Hardware



IXH620 Gen2 PCle XMC Host Adapter

Features

- PCI Express 2.1 compliant 5.0 GT/s per lane
- x8 PCle port 40 GT/s
- VITA 42.0-2005, ANSI/VITA 42.3-2006 compliant
- PCI Express External Cabling Specification
- PCle x8 iPass Connectors

- Copper cable connections up to 7 meters copper connection
- Non-transparent bridging to cabled PCI Express systems
- Short XMC form factor
- XMC P15 connector

Specifications

Link Speeds 40 GT/s		Power Consumption	7 watts
'	0.74 minutes and laterate (and laterate and laterate)	Mechanical Dimensions	XMC Short form factor
Application Performance	0.74 microsecond latency (application to application)	Operating Environment	Operating Temperature: 0°C -55°C Relative Humidity: 5% -95% non-condensing
Specifications	PCI Express Base Specification 2.1 VITA 42.0-2005, ANSI/VITA 42.3-2006	User Configuration Modes	Non-transparent(NTB)
Topologies	Point to point, Switched	Product Codes	IXH620 Host /Target / NTB adapter
Cable Connections	x8 iPass copper cable support Supports x8 to x4 transition cables		

Host to host connections

The IXH620 connects single board computers or systems running a distributed processing environment. Industrial or military customers requiring redundancy or increased compute resources use the IXH620 by itself or in conjunction with the IXS600 switch. Figure 20 illustrates connecting two single board computers with the IXH620. Fast data transfers are enabled through Dolphin's shared memory mechanism.



Figure 20: two node connection with XMC adapter

PCle Host/Target Adapters

Dolphin's PCIe Host/Target Adapters are high performance cabled interface to external IO subsystems. All transparent host and target adapters provide standard features for transparent bridging (TB), along with host and clock isolation.

Various host/target adapters can be configured to support various connection configurations including switched or point to point. They are designed to support various applications including GPU farms, test and measurement equipment, medical equipment, and storage subsystem. Each adapter is configurable as either a host adapter or target adapter using an on-board DIP-Switch to select between host and target operations.

These adapters support various cabling specification including iPass or the new PCI Sig 3.0 specification. Some adapter can also be used with a standard MiniSAS-HD cable when the Dolphin card is both the host and target adapter. Our new Gen3 adapters supports the new CMI functionality when used with a PCIe 3.0 cable and can therefore connect to a CMI compliant PCIe target device.

The adapters are carefully designed for maximum cable length. Some boards support copper cables up to 9 meters at full PCI Express Gen3 speed. Fiber optics extends this distance to 100 meters.

Features

- PCI Express compliant
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Copper and fiber-optic cable connections
- Full host clock isolation. Supports hosts running both CFC and SSC
- Low Profile PCIe form factor and XMC form factors
- EEPROM for custom system configuration
- Link status LEDs through face plate

Specifications

PCle Bracket	Full height plate mounted Half height plate included			Operating Temperature: 0°C - 55°C (32°F - 131°F) Operating Temperature with AOC: 0°C - 45°C (32°F
Configuration	DIP-switch Host /Target /Long cable /short cable /safe boot			- 113°F) Air Flow: 150 LFM
Regulatory	CE Mark FCC Class A UL94V-0 compliant RoHS Compliant			Operating Temperature: 0°C - 50°C (32°F - 122°F) Air Flow: ~0 LFM Relative Humidity: 5% - 95% (non- condensing)
Operating Systems supported	All			



PXH832 Gen 3 Host/Target Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Host and target operation
- Quad SFF-8644 connector
 - » PCI Express 3.0 cables
 - » MiniSAS -HD cables
- Four x4 Gen3 PCI Express cable ports that can be configured as:
 - » One x16 PCI Express port
 - » Two x8 PCI Express ports

- Copper and fiber-optic cable connectors
- Full host clock isolation. Supports hosts running both CFC and SSC
- Low Profile, half length PCle form factor
- EEPROM for custom system configuration
- Link status LEDs through face plate

Specifications

Link Speeds	32 GT/s per port / 128 GT/s	Power Consumption	10 Watts (typical, 14 Watts worst case) + 800 miliwatts
Application Performance	<130 nanoseconds cut through latency port to port		(typical) pr connected x4 AOC
Active Components	Broadcom /PLX Gen 3 PCle Switch	Mechanical Dimensions	Low profile, Half Length - 68.90 mm (2.731 inches) x 167.65 mm (6.600 inches)
PCI Express	Base Specification 3	PCle Bracket	Full height plate mounted Half height plate included
Topologies	Transparent Host/Target up to 4 devices	Product Codes	PXH832 Host/Target Adapter
Cable Connections	Quad SFF-8644 connector PCIe 3.0 and MiniSAS HD cables copper cables, 0.5 - 9 meters Fiber Optic -100 meters		

Topology Support

The PXH832 adapter is capable of being configured as a host or a target adapter. Figure 21 illustrates the some of the various topologies supported by the PXH832. It can support up to 4 PCle expansion units without an external switch. As a host adapter, the PXH832 connects to PCle targets via PCle 3.0 cables. It can connect to other PXH832 boards as a target or a custom target adapters. The PXH832 can be configured as a x16, x8, or x4 connection.

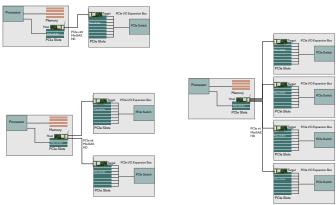


Figure 21: PXH832 Transparent Topology

PXH842 Gen 3 PCle Host/ Target Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Host and target operation
- Samtec FireFly Connections
- Four x4 Gen3 PCI Express cable ports that can be configured as:
 - » One x16 PCI Express port
 - » Two x8 PCI Express ports
 - » Four x4 PCI Express ports

- Fiber-optic cable connectins only
- Full host clock isolation. Supports hosts running both CFC and SSC
- Low Profile, half length PCle form factor

Specifications

Link Speeds	32 GT/s per port /128 GT/s	Power Consumption	10 Watts (typical, 14 Watts worst case) + 800 milliwatts	
Application Performance	0.54 microsecond latency (application to application)		(typical) pr connected x4 AOC	
, ppacation i chomianoc	<130 nanoseconds cut through latency port to port	Mechanical Dimensions	, ,	
Active Components	Broadcom/PLX Gen 3 PCle Switch with DMA		167.65 mm (6.600 inches)	
/ tenve components	bloadcom/1 EX den o 1 cle switch with blw/1	Product Codes	PXH842 PCle Host/Target Adapter	
PCI Express	Base Specification 3	Floudel Codes	FAI 1042 FCIe Flost/Taigei Adapiel	
Topologies	Point to point or 3 node Mesh Topology			
1	· · · · · · · · · · · · · · · · · · ·			
Cable Connections	Samtec FireFly Transceivers Fiber Optic -100 meters			

Topology Support

The PXH842 adapter is capable of being configured as a host or a target adapter. Figure 22 illustrates the various configurations supported by the PXH842. It can support up to 4 PCIe expansion units without an external switch. As a host adapter, the PXH842 connects to PCIe targets via MPO cables to Samtec Fiberfly transceivers. It can connect to other PXH842 boards as a target or a custom target adapters. The PXH842 can be configured as a x16, x8, or x4 connection.

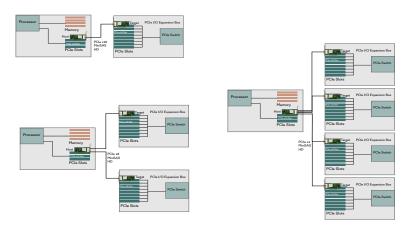


Figure 22: PXH842 Switchless Transparent Topology



MXH832 Gen 3 Host/Target Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Microsemi PFX 32 lane switch
- Link compliant with Gen 1, Gen 2, and Gen 3 PCle
- Host and target operation
- Quad SFF-8644 connector
 - » PCI Express 3.0 cables
 - » MiniSAS-HD cables

- Copper and fiber-optic cables
- MXH832 supports the following port configurations
 - » One x16 PCle port
 - » Two x8 PCle ports
 - » Four x4 PCle ports
- Full host Clock isolation support. Automatic support for host running CFC or SSC.

Specifications

mm (6.6 inches) Full height plate mounted
Full height plate mounted
Half height plate included
g) CE Mark FCC Class A UL94V-0 compliant
RoHS Compliant
nent Operating Temperature: 0°C - 55°C (32°F - 131°F) Air Flow: 150 LFM Relative Humidity: 5% - 95% (non-condensing)
DIP-switch Host / Target / x4,x8,x16 link / Safe Boot / Edge Clock
Select
MXH832 Host/Target Adapter

Topology Support

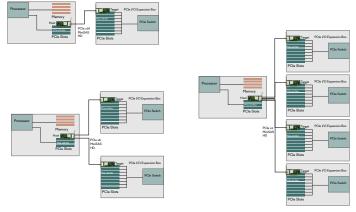


Figure 23:MXH832 I/O Expansion Configurations

PXH812 Gen 3 Host/Target Adapter

Features

- PCI Express Gen3 compliant 8.0 GT/s per lane
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Host and target operation
- PCI Express iPass cables
- One x8 Gen3 PCI Express cable port that can be configured as:
- Copper and fiber-optic cable connectors

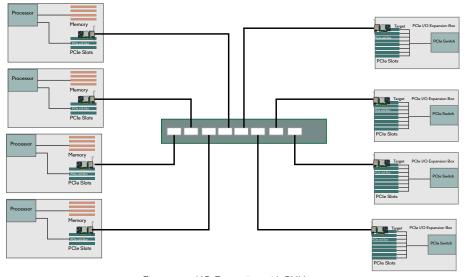
- Full host clock isolation. Supports hosts running both CFC and SSC
- Low Profile, half length PCle form factor
- EEPROM for custom system configuration
- Link status LEDs through face plate

Specifications

Link Speeds	64 GT/s
Cut through latency	138 nanoseconds
Active Components	Broadcom (PLX/Avago) PCle Switch
PCI Express	Base Specification 3
Topologies	Switch/ point to point
Cable Connections	x8 iPass copper cable, fiber optic cable support Supports x8 to x4 transition cables
Power Consumption	3.3 Volt 12 watts
Mechanical Dimensions	Low profile - 68.90 mm (2.731 inches) x 120 mm (6.600 inches)

Operating Environment	Operating Temperature: 0°C -55°C Relative Humidity: 5% -95% non-condensing
Usage Modes	Transparent Host/Target
Configuration	Dip-switch configurable host / target
Mounting Plates	Full height plate installed Half height plate included with board
Product Codes	PXH812 Host/ Target Adapter

Topology Support



Figuure 24: I/O Expansion with PXH812

IXH611 Gen2 PCle Host/Target Adapters

Features

- PCI Express 2.1 compliant 5.0 GT/s per lane
- x8 PCI Express port 40 GT/s
- Link compliant with Gen1 and Gen2 PCI Express
- Support Gen1, Gen2, and Gen3 PCle Slots
- PCI Express x8 iPass Connectors

- Copper cables up to 7 meters
- Transparent bridging to cabled I/O devices
- Low Profile PCle form factor

Specifications

Link Speeds	40 GT/s	Operating Environment	Operating Temperature: -10°C -60°C Relative Humidity: 5% -95% non-condensing
PCI Express Topologies	Base Specification 2.1 Point to point, Switched	User Configuration Modes	Transparent Host Target adapter Non-transparent Host(NTB)
Cable Connections	x8 iPass copper cable support Supports x8 to x4 transition cables	Product Codes	IXH611 - Host/Target Adapter
Power Consumption	7 watts		
Mechanical Dimensions	PCI Express Card Electromechanical Specification 2.0		

Remote I/O Connections

The IXH611 functions as a high quality transparent connection to remote PCle I/O subsystems. These subsystems include test equipment, I/O expansion systems, specialized equipment, and storage systems. The IXH611 is specially designed for higher signal quality and support for spread spectrum clocking. The IXH611 is used as a target adapter in I/O expansion applications.



Figure 25: I/O expansion with PCI Express

NTILE Delphin

IXH620 Gen2 PCle XMC Host Adapter

Features

- PCI Express 2.1 compliant 5.0 GT/s per lane
- x8 PCle port 40 GT/s
- Link compliant with Gen1 PCI Express
- VITA 42.0-2005, ANSI/VITA 42.3-2006 compliant
- PCI Express External Cabling Specification
- PCle x8 iPass Connectors

- Copper cable connections up to 7 meters copper connections
- Clock isolation support
- Transparent bridging to cabled I/O devices
- Short XMC form factor
- EEPROM for custom system configuration
- XMC P15 connector

Specifications

Link Speeds	40 GT/s	Operating Environment	Operating Temperature: 0°C -55°C Relative Humidity: 5% -95% non-condensing	
Application Performance	cation Performance 0.74 microsecond latency (application to application) User Config		Transparent/non-transparent(NTB)	
Specifications	PCI Express Base Specification 2.1 VITA 42.0-2005, ANSI/VITA 42.3-2006	Regulatory	CE Mark EN 55022,EN 55024-A18:A2, EN 61000-6-2	
Topologies	Point to point, Switched		FCC Class A UL94V-0 compliant	
Cable Connections	x8 iPass copper cable support Supports x8 to x4 transition cables		RoHS Compliant	
Power Consumption	7 watts	Product Codes	IXH620 Host /Target / NTB adapter	
Mechanical Dimensions	XMC Short form factor			

Remote I/O subsystems

To extend the I/O capabilities of an XMC enabled system, the IXH620 supports host adapter or target adapter configurations. Industrial and Military customers requiring increased I/O bandwidth for graphics, processing, or data collection can add IXH620 enabled XMC carrier cards and chassis. Figure 26 illustrates connecting a standard server to and XMC enabled chassis to attach additional XMC cards for test system or increased functionality.



Figure 26: connect embedded equipment to hosts

PCle Switch Boxes

PCle External Switch Boxes

Dolphin PCI Express switch boxes provide low latency, highly efficient switching for high performance applications. These powerful switch products enable I/O scaling and inter-processor communication by combining transparent and non-transparent bridging capabilities with Dolphin's eXpressWare software and clustering technology. Users can connect multiple PCI Express end points or create a highly efficient compute cluster with PCs, servers, or SBCs with XMC sites.

Dolphin's switch boxes work as the switching element within Dolphin's product line. Each switch port delivers maximum bandwidth to each device while maintaining backwards compatibility with Gen1 and Gen2 components. Dolphin products utilizes standard cable connectors such as iPass and MiniSAS HD as well as PCle 3.0 cables. They support both copper or fiber-optic cabling. Customer can link multiple standardized PCI Express products such as PXI chassis, storage, and I/O expansion units.

For Non Transparent Bridging (NTB) or clustering applications, the

switch-boxes integrate with PCI Express Host Adapters or XMC Adapter. The total NTB solution solves many of the problems related to PCI Express operations, such as power sequencing and standard software. Dolphin customers avoid the severe power-on requirements normally associated with PCI Express. Hosts, cables, and the switch can be hot-swapped and power cycled in any sequence for real plug and play.

Switch-boxes can be partitioned into several virtually independent partitions, e.g. mixing NTB and Transparent functionality on separate ports.

Dolphin switch boxes support our eXpressWare comprehensive software suite. They provide a scalable solution for financial computing, simulation, Military, and enterprise business applications.

Features

- Fiber-optic and copper cable support
- Link compliant with Gen1, Gen2, and Gen3 PCle
- Copper and fiber-optic cable connections
- Transparent and Non Transparent support
- Hot Plug PCI Express cabling support in NTB mode
- Built in management processor

- Boot configuration and user data support for cluster and system configuration
- 19 Inch 1U rack mountable chassis
- Front and rear operational status and alert LEDs
- Redundant Fans

Topologies

Dolphin Switches are key element in Dolphin's inter-processor connectivity strategy. Industrial, military, or enterprise customer can create diverse multiprocessing configurations. The hybrid configuration illustrated shows single board computers and data nodes connected through the switch. The IXH610 host adapter and IXH620 XMC adapter are used to connect to different compute nodes.

Increasing the number of I/O components in a system is accomplished by using a switch with PCIe I/O expansion boxes. Figure 27 illustrates the IXS600 connecting 7 additional I/O expansion boxes. These boxes can accommodate components such as sensors, graphics, co-processors, video capture cards, and other I/O devices.

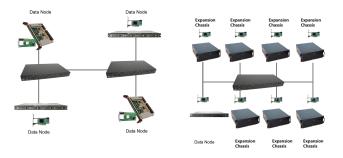


Figure 27: I/O and hybrid configuration

PCle Switch Boxes

MXS824 Gen3 PCle Switch

Features

- 24 PCI Express Gen3 x4 ports
- 32 GT/s per port
- SFF-8644 Connectors
- NTB or Transparent Use
- PCle 3.0 or MiniSAS-HD cables
- Hot plug cabling support



- 19 inch 1U rack mountable
- Redundant Fans
- Port Status LEDs
- Copper and Fiber-optic cables
- Ethernet based management and monitoring

Specifications

Link Speeds	32 GT/s per port	Operating Environment	Operating Temperature: 0°C -55°C	
Application Performance	170ns port latency		Relative Humidity: 5% -95% non-condensing	
Active Components	Microsemi Switchtec PCle Gen3 Switch	Storage Environment	Storage Temperature: -25°C - 70°C Relative Humidity: 10% - 95% (non- condensing)	
PCI Express	Base Specification 3.1	Software	SuperSockets™ Berkley Sockets API	
Ports	24 - x4 non-blocking 32 GT/s ports		Microsoft WinSock2/LSP support SISCI API	
Cable connections	x4 MiniSAS-HD cable Connections		TCP/IP Driver	
	Copper cables- up to 5 meters at Gen3 speed Fiber- Optic cable support- up to 100 meters	Pending Safety test	IEC 60950-1:2005 (Second Edition), Am 1: 2009 EN 60950-1:2006 + A11:2009 + A1:2010 + A12:2011 A CB test certificate is available upon request.	
Management	Rj45 and USB management ports Operational status and alert LEDs			
Power	Auto-sensing power supply 110 - 240 V AC 50-60Hz Power consumption : Max 80 Watts	Regulatory	CE Mark EN 55022,EN 55024-A1&A2, EN 61000-6-2 FCC Class A UL94V-0 compliant	
Mechanical	1U, 19 inch rackmountable chassis		RoHS	
	440mm (W) x 300mm (D) x 45mm(H) Redundant Fans	Product Codes	IXS60	
User Configuration Modes	ser Configuration Modes Transparent/non-transparent(NTB)			

Scalability

The MXS824 support up to 24 end points at x4 PCle speeds. The switch can be configured as x4 or x8 or x16 ports. At these speeds, it can support 24, 12, or 6 end points. Ultimately, multiple MXS824s can be connected to scale out to 64 end points or higher.

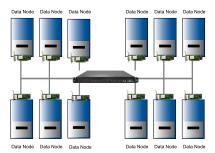


Figure 28: Scalability of switches

PCIe Switch Boxes



IXS600 Gen3 PCle Switch

Features

- PCI Express 3.0 compliant -8.0 GT/s per lane
- Eight PCI Express Gen3 x8 ports
- PCI Express x8 iPass Connectors
- Auto-training to lower lane widths
- Supports x4 lanes with a transition cable

- Link compliant with Gen1 and Gen2 PCI Express
- Transparent and Non Transparent support
- PCI Express External Cabling Specification

Specifications

Link Speeds	64 GT/s per port	User Configuration Modes	Transparent/non-transparent(NTB)
Application Performance	6595 MB/s application data rate 200ns port latency	Operating Environment	Operating Temperature: 0°C -55°C Relative Humidity: 5% -95% non-condensing
Ports	8 - x8 non-blocking 64 GT/s ports	Regulatory	CE Mark
Cable connections	x8 iPass copper cables		EN 55022,EN 55024-A1&A2, EN 61000-6-2 FCC Class A
Management	nagement Ethernet management port Operational status and alert LEDs		UL94V-0 compliant RoHS
Power	Auto-sensing power supply 110 - 240 V AC 50-60Hz Power consumption : Max 80 Watts	Product Codes	IXS600 Gen3 100 Mhz
Mechanical	1U, 19 inch rackmountable chassis 440mm (W) x 300mm (D) x 45mm(H) Redundant Fans		

Scalability

Scalability is achieved by connecting multiple switches. Multiple IXS600 switches are used for larger reflective memory applications or creating larger processing clusters.

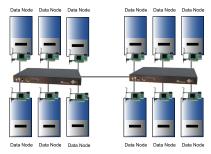


Figure 29: Scalability of switches

Hardware Comparison - PCle Gen 3 with SFF-8644 Connector

Feature	PXH830	PXH832	MXH830	MXH832
Use	NTB	Transparent Host/ Target	NTB	Transparent Host/ Target
Form factor	Short/ Low profile PCle	Short/ Low profile PCle	Short/ Low profile PCle	Short/ Low profile PCle
PCle max connection speed	x16 Gen3	x16 Gen3	x16 Gen3	x16 Gen3
NTB	Yes	No	Yes	No
Transparent Target	No	Yes	No	Yes
Transparent Host	No	Yes	No	Yes
Clocking	100Mhz	100MHz	100Mhz	100MHz
Max copper cable length	9 Meter	9 Meter	9 Meter	9 Meter
Fiber support	100 Meter	100 Meter	100 Meter	100 Meter
Switch support	MXS824	MXS824	MXS824	MXS824
Scalability	3 nodes without switch 64/128 nodes with switch	1-4 expansion without switch	5 nodes without switch 64/128 nodes with switch	1-4 expansion without switch
Number of reflective memory segments	4(16)	N/A	4 (16)	N/A
Max PIO Performance	10.2 GB/s	N/A		N/A
Max DMA Performance	11 GB/s	N/A		N/A
Scipp latency back to back	0.54 μs	N/A		N/A
Scipp latency switch	0.71 μs	N/A		N/A

Hardware Comparison - PCle Gen 2/3 with iPass Connector

Feature	PXH810	PXH812	IXH610/IXH611	IXH620
Use	NTB	Transparent Host/ Target	NTB/ Transparent Host/ Target	NTB/ Transparent Host/Target
Form factor	Short/ Low profile PCle	Short/ Low profile PCle	Short/ Low profile PCle	Short XMC
PCle max connection speed	x8 Gen3	x8 Gen3	x8 Gen2	x8 Gen2
NTB	Yes	No	Yes	Yes
Transparent Target	No	Yes	IXH610-No IXH611-Yes	Yes
Transparent Host	No	Yes	Yes	Yes
Clocking	100Mhz	100MHz	100MHz	100MHz
Max copper cable length	5 Meter	5 Meter	7 Meter	7 Meter
Fiber support	100 Meter	100 Meter	No	No
Switch support	IXS600	IXS600	IXS600	IXS600
Scalability NTB, general use	14 nodes	N/A	20 nodes	20 nodes
Scalability Reflective memory functionality only	14 nodes	N/A	56 nodes	56 nodes
Transparent scalability	256 bus numbers	256 bus numbers	256 bus numbers	256 bus numbers
Maximum reflective memory segment size	2 GB	N/A	2 GB	2 GB
Number of reflective memory segments	4 (16)	N/A	4	4
Total reflective memory size	4 x 2 GB	N/A	4 x 2 GB	4 x 2 GB
Max PIO Performance	5312 MB/s	N/A	2950 MB/s	2950 MB/s
Max DMA Performance	6695 MB/s	N/A	3500 MB/s	3500 MB/s
Scipp latency back to back	0.54 μs	N/A	0.74 µs	0.74 μs
Scipp latency switch	0.71 μs	N/A	0.9 μs	0.9 μs

Hardware Comparison - PCle Switch Boxes

Feature	MXS824 PCle Switch	IXS600 PCle Switch
PCle	Gen3	Gen3
Link Speed	32 GTps/s per x4	64 GTps/s per x8
Port Latency	170ns	200ns
Active Components	Microsemi Switchtec® PCI Express Gen3 Switch	IDT PCI Express Gen3 Switch
PCI Express	Base Specification 3.1	Base Specification 3.0
Ports	24 - x4 non blocking PCIe Gen3 ports	8 - x8 Non blocking PCle Gen3 ports
Port configurations	Flexible port configurations - E.g 24 -x4, 12 -x8, 6 - x16 ports or 2x16+2x+12x4	8- x8 ports
Operating Modes	NTB and Transparent	NTB and Transparent
Connector Type	SFF-8644	iPass
Cable Connections	x4 MiniSAS HD or PCle 3.0 cable connections	x8 - iPass Cable connections
Cable Types	Copper cables - up to 5 meters at Gen3 speeds Fiber-Optic cables - up to 100 meters at Gen3 speeds	Copper Cables - up to 5 meter at Gen3 speeds
Dimensions	1U 19 inch rack mount	1U 19 inch rack mount
Power consumption	Auto-sensing power supply 110-240v AC 50- 60 Hz	Auto-sensing power supply 110-240v AC 50- 60 Hz
Additional ports	1 Ethernet Management Port, 1 USB port for firm- ware, 1 SD-card slot	1 Ethernet Management Port, 1 USB port for firmware
Power management	Advanced power management - hibernation, wake via Ethernet	N/A

Product Comparison Charts

Software Comparison

Feature	SISCI	SuperSockets	IPoPCle Driver
Linux Platform Support	x86, x86_64 ARM 32/64. PPC	x86, x86_64 ARM 64	x86, x86_64 ARM 64
Kernel 2.6 - 4.x	NVidia Tegra	PPC	PPC
Windows Vista, 7, 10, Server 2008-2016 Platform Support	x86, x86_64	x86, x86_64	x86, x86_64
RTX Platform Support	x86, x86_64	No	No
VxWorks 6.9 , 7.0	x86, x86_64 PPC	No	No
Latency	0.54 μs Linux	0.98 μs Linux	5.6 μs Linux
Max Bandwidth	11 GB/s Linux	65 Gb/s	65 Gb/s
Reflective Memory Support	Yes	N/A	N/A
Address based Multi-cast support	Yes	N/A	N/A
TCP Support	N/A	Yes	Yes
UDP Support	N/A	Linux -Yes Windows - No	Yes
UDP Multi-cast Support	N/A	Linux -Yes Windows - under development	Linux -under development Windows - Yes
Application modifications required	Yes	No	No
Cross O/S and Platform data transfer support	All	User space Linux / Windows	No
Peer to Peer Transfers support	Yes	N/A	N/A
Accelerated Loopback Support	Yes	Yes	No
Open Source code available	Yes	No	No
Licensing of software available	Yes	Yes	Yes
Chipset support	Microsemi Broadcom/PLX IDT Intel NTB	Microsemi Broadcom/PLX IDT Intel NTB	Microsemi Broadcom/PLX IDT Intel NTB

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